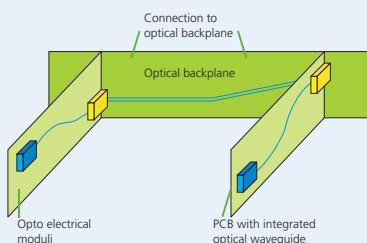
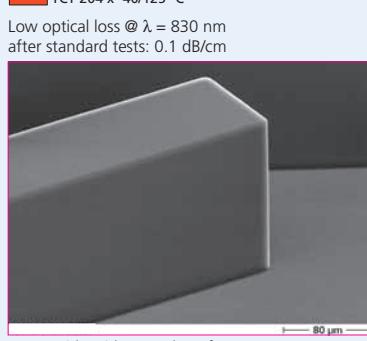
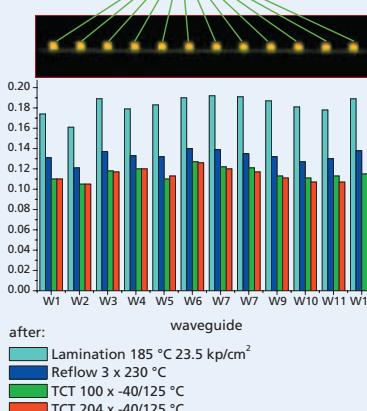
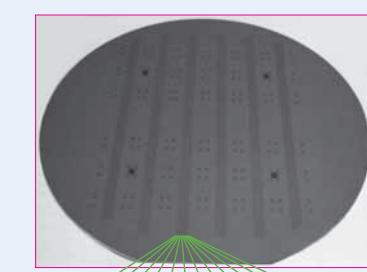


## EpoCore & EpoClad — New Materials for Optical Wave Guides in PCB

### For New Generation Interconnection Technology (NegIT)



New Generation Interconnection Technology (NegIT)



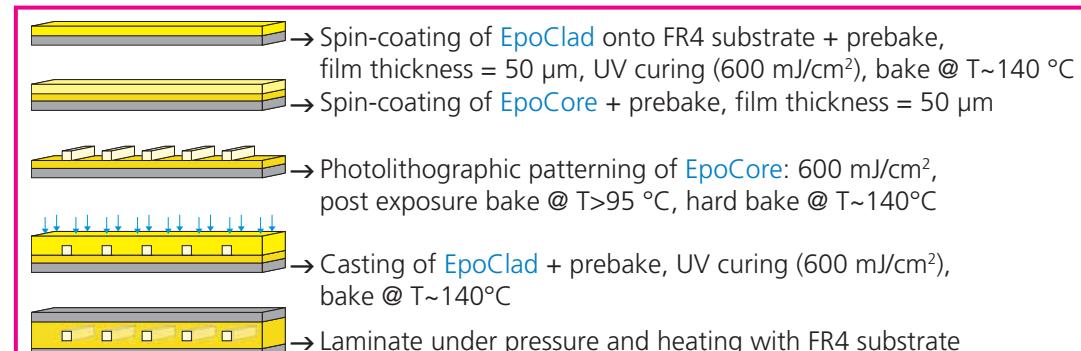
Waveguide with smooth surface and vertical sidewalls



No microcracks on critical spots

### Unique features

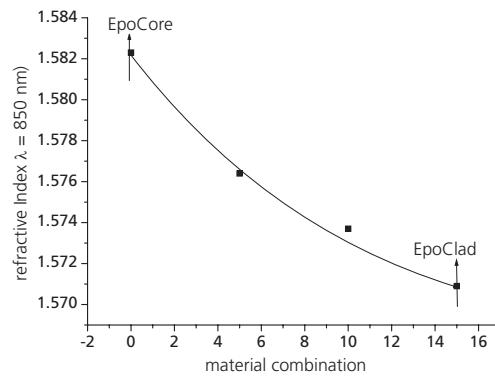
- Standard Lithography and PCB technology processing
- UV patterning of core and cladding
- High transmittance @ 850 nm
- High heat and pressure resistance
- Tunable refractive index (core/ cladding)



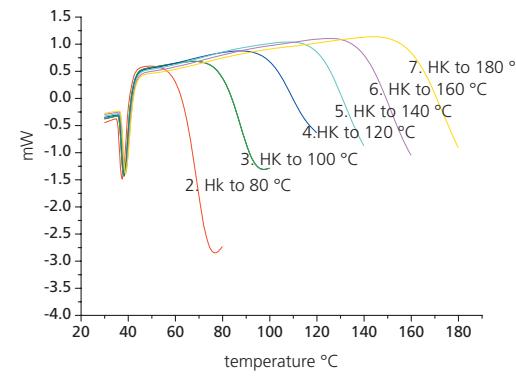
### Technical data

Resin typ	Epoxy duromer
Waveguide	Refractive index @ $\lambda = 830 \text{ nm}$ : EpoCore 1.58, EpoClad 1.57
Glass transition temperature	> 180 °C
Substrate	Standard FR4 (10x10 cm, 8 inch)
Lamination	Standard temperature > 185 °C, pressure 23 kp/cm <sup>2</sup>
Standard tests	Reflow: 3 x 15 s @ T = 230 °C; TCT: 240 x -40 °C / +120 °C
Optical loss	~0.2 dB/cm @ $\lambda = 850 \text{ nm}$

- Fabrication with conventional equipment (UV lithography and PCB)
- High thermal stability (> 230 °C), high glass transition temperature (> 180 °C)
- Excellent stability of embedded, laminated waveguides after reflow and TCT tests



Refractive index tuning by copolymerisation



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